



## Pin Assignment:

Pin Number	Signal Name	Pin Number	Signal Name
1	TMDS 2+	11	TMDS Clock Shield
2	TMDS 2 Shield	12	TMDS Clock -
3	TMDS 2-	13	CEC
4	TMDS 1+	14	HEC-
5	TMDS 1 Shield	15	SCL
6	TMDS 1-	16	SDA
7	TMDS 0+	17	Ground
8	TMDS 0 Shield	18	Power
9	TMDS 0-	19	Hot Plug/HEC+
10	TMDS Clock +	Shell	Shield

## Kind Properties:

Durability	5 000 Mating cycles
Connector Type	Mirco HDMI

## Material Properties:

Insulator Material	LCP
Insulator Flammability Rating	UL94 V-0
Contact Material	Copper Alloy
Contact Plating <sup>1)</sup>	Selective Gold
Shielding Material	Brass
Shielding Plating	Tin
Contact Type	Stamped

<sup>1)</sup> Mating side / Solder side

## General Information:


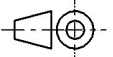

Operating Temperature	-25 up to +85 °C
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## Electrical Properties:

Properties		Value	Unit	Tol.
Rated Current	I <sub>R</sub>	0.5	A	
Working Voltage		40	V (AC)	
Withstanding Voltage		250	V (AC)	
Contact Resistance	R	10	mΩ	max.
Insulation Resistance	R <sub>ISO</sub>	100	MΩ	min.

## Certification:

HDMI Approval	Approved
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	CHECKED	REVISION	DATE (YYYY-MM-DD)	GENERAL TOLERANCE	PROJECTION METHOD	
	BB0	001.001	2022-09-13	DIN ISO 2768-1m		
 <b>WÜRTH ELEKTRONIK</b> MORE THAN YOU EXPECT	Würth Elektronik eiSos GmbH & Co. KG EMC & Inductive Solutions Max-Eyth-Str. 1 74638 Waldenburg Germany Tel. +49 (0) 79 42 945 - 0 www.we-online.com eiSos@we-online.com				DESCRIPTION <b>WR-COM Micro HDMI Horizontal SMT</b>	
	ORDER CODE <b>685119248123</b>				BUSINESS UNIT eiCan	STATUS Valid
SIZE/TYPE Type D						

### Classification Reflow Profile for SMT components:



### Classification Reflow Soldering Profile:

Profile Feature		Value
Preheat Temperature Min	$T_{s \min}$	150 °C
Preheat Temperature Max	$T_{s \max}$	200 °C
Preheat Time $t_s$ from $T_{s \min}$ to $T_{s \max}$	$t_s$	60 - 120 seconds
Ramp-up Rate ( $T_L$ to $T_p$ )		3 °C/ second max.
Liquidous Temperature	$T_L$	217 °C
Time $t_L$ maintained above $T_L$	$t_L$	60 - 150 seconds
Peak package body temperature	$T_p$	$T_p \leq T_c$ , see Table below
Time within 5°C of actual peak temperature	$t_p$	20 - 30 seconds
Ramp-down Rate ( $T_p$ to $T_L$ )		6 °C/ second max.
Time 25°C to peak temperature		8 minutes max.

refer to IPC/ JEDEC J-STD-020E

### Package Classification Reflow Temperature ( $T_c$ ):

Properties	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000
PB-Free Assembly   Package Thickness < 1.6 mm	260 °C	260 °C	260 °C
PB-Free Assembly   Package Thickness 1.6 mm - 2.5 mm	260 °C	250 °C	245 °C
PB-Free Assembly   Package Thickness > 2.5 mm	250 °C	245 °C	245 °C

refer to IPC/ JEDEC J-STD-020E

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This electronic component has been designed and developed for usage in general electronic equipment only. This product is not authorized for use in equipment where a higher safety standard and reliability standard is especially required or where a failure of the product is reasonably expected to cause severe personal injury or death, unless the parties have executed an agreement specifically governing such use. Moreover Würth Elektronik eiSos GmbH & Co KG products are neither designed nor intended for use in areas such as military, aerospace, aviation, nuclear control, submarine, transportation (automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network etc.. Würth Elektronik eiSos GmbH & Co KG must be informed about the intent of such usage before the design-in stage. In addition, sufficient reliability evaluation checks for safety must be performed on every electronic component which is used in electrical circuits that require high safety and reliability functions or performance.

## Cautions and Warnings:

### The following conditions apply to all goods within the product series of the Connectors of Würth Elektronik eiSos GmbH & Co. KG:

#### General:

- This mechanical component is designed and manufactured for use in general electronic equipment.
- Würth Elektronik must be asked for written approval (following the PPAP procedure) before incorporating the components into any equipment in fields such as military, aerospace, aviation, nuclear control, submarine, transportation (automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network, etc. where higher safety and reliability are especially required and/or if there is the possibility of direct damage or human injury.
- Mechanical components that will be used in safety-critical or high-reliability applications, should be pre-evaluated by the customer.
- The mechanical component is designed and manufactured to be used within the datasheet specified values. If the usage and operation conditions specified in the datasheet are not met, the component may be damaged or dissolved.
- Do not drop or impact the components, the component may be damaged.
- Prevent any damage or scratches on the component, especially on the actuator.
- Direct mechanical impact to the product shall be prevented (e.g overlapping of the PCB's).
- Würth Elektronik products are qualified according to international standards, which are listed in each product reliability report. Würth Elektronik does not warrant any customer qualified product characteristics beyond Würth Elektronik's specifications, for its validity and sustainability over time.
- The responsibility for the applicability of the customer specific products and use in a particular customer design is always within the authority of the customer. All technical specifications for standard products do also apply to customer specific products.
- The mechanical component is designed to be used along with Würth Elektronik counterparts and tools. Würth Elektronik cannot ensure the reliability of these components while being used with other products.

#### Product Specific:

#### Soldering:

- The solder profile must comply with the technical product specifications. All other profiles will void the warranty.
- All other soldering methods are at the customers' own risk.

#### Cleaning and Washing:

- Washing agents used during the production to clean the customer application might damage or change the characteristics of the component, body, pins and termination. Washing agents may have a negative effect on the long-term functionality of the product.
- Using a brush during the cleaning process may deform function relevant areas. Therefore, we do not recommend using a brush during the PCB cleaning process.

#### Potting and Coating:

- If the product is potted in the customer application, the potting material might shrink or expand during and after hardening. Shrinking could lead to an incomplete seal, allowing contaminants into the components. Expansion could damage the components. We recommend a manual inspection after potting or coating to avoid these effects.

#### Storage Conditions:

- A storage of Würth Elektronik products for longer than 12 months is not recommended. Within other effects, the terminals may suffer degradation, resulting in bad solderability. Therefore, all products shall be used within the period of 12 months based on the day of shipment.
- Do not expose the components to direct sunlight.
- The storage conditions in the original packaging are defined according to DIN EN 61760-2.
- The storage conditions stated in the original packaging apply to the storage time and not to the transportation time of the components.


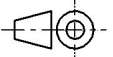

#### Packaging:

- The packaging specifications apply only to purchase orders comprising whole packaging units. If the ordered quantity exceeds or is lower than the specified packaging unit, packaging in accordance with the packaging specifications cannot be ensured.

#### Handling:

- Do not repeatedly operate the component with excessive force. It may damage or deform the component resulting in malfunction.
- In the case a product requires particular handling precautions, in addition to the general recommendations mentioned here before, these will appear on the product datasheet.
- The temperature rise of the component must be taken into consideration. The operating temperature is comprised of ambient temperature and temperature rise of the component. The operating temperature of the component shall not exceed the maximum temperature specified.

These cautions and warnings comply with the state of the scientific and technical knowledge and are believed to be accurate and reliable. However, no responsibility is assumed for inaccuracies or incompleteness.

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